L Number	Hits	Search Text	DB	Time stamp
1	617	(118/718).CCLS.	USPAT; US-PGPUB	2003/05/05 07:47
-	1	09/812,075	USPAT; US-PGPUB	2003/05/04 20:54
-	0	20020002945.URPN.	USPAT	2003/05/04 21:02
-	1	("5364481").PN.	USPAT; US-PGPUB	2003/05/04 21:16
-	138	((118/718).CCLS.) and cut$4	USPAT; US-PGPUB	2003/05/09 11:00
-	225	((118/718).CCLS.) and rotat$4	USPAT; US-PGPUB	2003/05/04 21:50
-	55	((118/718).CCLS.) and (rotat$4 with (open$3 clos$3 seal))	USPAT; US-PGPUB	2003/05/04 22:25
-	5	5364481.URPN.	USPAT	2003/05/04 22:03
-	5	5364481.URPN.	USPAT	2003/05/04 22:04
-	5	5364481.URPN.	USPAT	2003/05/04 22:04
-	49	(118/$.ccls. 156/345.$.ccls.) and (rotat$4 with triang$4)	USPAT; US-PGPUB	2003/05/04 22:43
-	2398	((118/314) or (118/315) or (118/324) or (118/325) or (156/345.2) or (156/345.22) or (156/345.31)).CCLS.	USPAT; US-PGPUB	2003/05/04 22:44
-	1	(((118/314) or (118/315) or (118/324) or (118/325) or (156/345.2) or (156/345.22) or (156/345.31)).CCLS.) and (rotat$4 with triang$4)	USPAT; US-PGPUB	2003/05/04 22:45
-	2	c23c016$.ipc. and (rotat$4 with triang$4)	EPO; JPO; DERWENT	2003/05/04 22:45
-	332	(118/227).CCLS.	USPAT; US-PGPUB	2003/05/05 09:09
-	559	((118/227) or (118/224)).CCLS.	USPAT; US-PGPUB	2003/05/05 07:58
-	1041	(118/323).CCLS.	USPAT; US-PGPUB	2003/05/05 07:58
-	462	((118/323).CCLS.) and (rotat$4)	USPAT; US-PGPUB	2003/05/05 07:59
-	7	5429676.URPN.	USPAT	2003/05/05 08:40
-	1	5672376.URPN.	USPAT	2003/05/05 08:52
-	2	("3448717" | "5040729").PN.	USPAT	2003/05/05 09:03
-	0	6358320.URPN.	USPAT	2003/05/05 09:04
-	45	(118/311).CCLS.	USPAT; US-PGPUB	2003/05/05 09:17
-	3	2000077.URPN.	USPAT	2003/05/05 09:16
-	320	(118/309).CCLS.	USPAT; US-PGPUB	2003/05/05 09:17
-	1	2572743.URPN.	USPAT	2003/05/05 09:23
-	1	5861062.URPN.	USPAT	2003/05/05 09:35
-	62	(156/345.22).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	160	(156/345.33).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	126	(156/345.34).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	0	("441 442").PN.	USPAT; US-PGPUB	2003/05/05 09:54
-	38	(156/345.2).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	267	((156/345.33).CCLS.) ((156/345.34).CCLS.)	USPAT; US-PGPUB	2003/05/05 10:26
-	1	("2157944").PN.	USPAT; US-PGPUB	2003/05/05 10:01
-	3	2157944.URPN.	USPAT	2003/05/05 10:01
-	74	118/715.ccls. and triang$4	USPAT; US-PGPUB	2003/05/05 10:26
-	22	(((156/345.33).CCLS.) ((156/345.34).CCLS.)) and triang$4	USPAT; US-PGPUB	2003/05/05 10:37
-	2	118/$.ccls. and (filament with cane)	USPAT; US-PGPUB	2003/05/05 10:45
-	31	(((156/345.33).CCLS.) ((156/345.34).CCLS.)) and conic$3	USPAT; US-PGPUB	2003/05/05 10:40
-	656	118/$.ccls. and ((chamber enclosure apparatus) with (triang$4 conical$4))	USPAT; US-PGPUB	2003/05/06 14:43

−	40	118/$.ccls. and (heat$3 with filament with (support mount))	USPAT; US-PGPUB	2003/05/05 13:34
−	29	filament with cane	USPAT; US-PGPUB	2003/05/05 10:48
−	21	filament with cane	EPO; JPO; DERWENT	2003/05/05 10:48
−	85	156/345.$.ccls. and ((chamber enclosure apparatus) with (triang$4 conical$4))	USPAT; US-PGPUB	2003/05/05 11:02
−	36	156/345.$.ccls. and ((cross$1section) with (triang$4 conical$4))	USPAT; US-PGPUB	2003/05/05 11:05
−	6	c23c016$.ipc. and ((cross$1section) with (triang$4 conical$4))	EPO; JPO; DERWENT	2003/05/05 11:10
−	1	("4993360").PN.	USPAT; US-PGPUB	2003/05/05 11:07
−	0	h011021.ipc. and ((cross$1section) with (triang$4 conical$4))	EPO; JPO; DERWENT	2003/05/05 11:11
−	30	(chamber apparatus enclosure) and ((cross$1section) with (triang$4 conical$4)) and (wafer semiconductor substrate)	EPO; JPO; DERWENT	2003/05/05 11:11
−	27	118/$.ccls. and (chamber adj (triang$4 conical$4))	USPAT; US-PGPUB	2003/05/05 15:56
−	1	118/$.ccls. and (vacuum with conduit with (detach$4))	USPAT; US-PGPUB	2003/05/05 12:00
−	2	156/345.$.ccls. and (heat$3 with filament with (support mount))	USPAT; US-PGPUB	2003/05/05 13:35
−	21	156/345.$.ccls. and (heat$3 with coil with (support mount))	USPAT; US-PGPUB	2003/05/05 13:37
−	407	(heat$3 with (coil filament) with (support$3 mount$3) with (detach$4 remov$4))	USPAT; US-PGPUB	2003/05/05 14:38
−	65	(heat$3 with (coil filament) with (support mount) with (detach$4 remov$4))	EPO; JPO; DERWENT	2003/05/05 14:43
−	0	60-161619	EPO; JPO; DERWENT	2003/05/05 13:55
−	2	"60161619"	EPO; JPO; DERWENT	2003/05/05 13:55
−	11	(heat$3 with (coil filament) with (support$3 mount$3) with (detach$4 remov$4) with clean$3)	USPAT; US-PGPUB	2003/05/05 14:43
−	446	(heat$3 with (support$3 mount$3) with (detach$4 remov$4) with clean$3)	USPAT; US-PGPUB	2003/05/05 14:48
−	118	(heat$3 with (coil filament) with (detach$4 remov$4) with clean$3)	USPAT; US-PGPUB	2003/05/05 14:43
−	9	c23c016$.ipc. and (heat$3 with (coil filament) with (detach$4 remov$4))	EPO; JPO; DERWENT	2003/05/05 14:46
−	109	(wafer substrate semiconductor) and (heat$3 with (coil filament) with (detach$4 remov$4))	EPO; JPO; DERWENT	2003/05/05 14:47
−	0	118/724.$.ccls. and (heat$3 with (support$3 mount$3) with (detach$4 remov$4) with clean$3)	USPAT; US-PGPUB	2003/05/05 14:49
−	5	118/724.ccls. and (heat$3 with (support$3 mount$3) with (detach$4 remov$4) with clean$3)	USPAT; US-PGPUB	2003/05/05 14:50
−	1	118/724.ccls. and (heat$3 with (support$3 mount$3) with (detach$4 remov$4) with (coil filament))	USPAT; US-PGPUB	2003/05/05 14:50
−	61	118/724.ccls. and (heat$3 with (support$3 mount$3) with (detach$4 remov$4))	USPAT; US-PGPUB	2003/05/05 14:53
−	1	118/724.ccls. and ((filament coil) with heat$3 with (support$3 mount$3) with (detach$4 remov$4))	USPAT; US-PGPUB	2003/05/05 14:54
−	3	118/724.ccls. and ((filament coil) with (support$3 mount$3) with (detach$4 remov$4))	USPAT; US-PGPUB	2003/05/05 14:54
−	1	("5053252").PN.	USPAT; US-PGPUB	2003/05/05 15:37
−	337	118/$.ccls. and (vacuum with (mov$4 detach$4 remov$4) with (conduit pipe line))	USPAT; US-PGPUB	2003/05/05 16:13

-	216	118/$.ccls. and (vacuum with (detach$4 remov$4) with (conduit pipe line))	USPAT; US-PGPUB	2003/05/05 16:14
-	111	118/715-733.ccls. and (vacuum with (detach$4 remov$4) with (conduit pipe line))	USPAT; US-PGPUB	2003/05/05 16:21
-	37	c23c016$.ipc. and (vacuum with (detach$4 remov$4) with (conduit pipe line))	EPO; JPO; DERWENT	2003/05/05 16:21
-	0	c23c016$.ipc. and (vacuum with (disconnect$4) with (conduit pipe line))	EPO; JPO; DERWENT	2003/05/05 16:33
-	17	118/715-733.ccls. and (vacuum with (detach$4 disconnect$3) with (conduit pipe line))	USPAT; US-PGPUB	2003/05/05 16:22
-	17	c23c016$.ipc. and (vacuum with (connect$4) with (conduit pipe line) with (plural$3 multipl$3))	EPO; JPO; DERWENT	2003/05/05 16:39
-	0	c23c016$.ipc. and (vacuum with (disconnect$4) with (conduit pipe line) with (plural$3 multipl$3))	EPO; JPO; DERWENT	2003/05/05 16:37
-	28	c23c016$.ipc. and (vacuum with (mov$4) with (source))	EPO; JPO; DERWENT	2003/05/05 16:39
-	1073	(118/726).CCLS.	USPAT; US-PGPUB	2003/05/06 10:30
-	131	((118/726).CCLS.) and filament	USPAT; US-PGPUB	2003/05/06 10:31
-	291	((118/726).CCLS.) and (filament coil)	USPAT; US-PGPUB	2003/05/06 10:48
-	0	((118/726).CCLS.) and thermoform$3	USPAT; US-PGPUB	2003/05/06 14:25
-	1248	(118/719).CCLS.	USPAT; US-PGPUB	2003/05/06 14:28
-	0	((118/719).CCLS.) and thermoform$3	USPAT; US-PGPUB	2003/05/06 14:28
-	1	("5811050").PN.	USPAT; US-PGPUB	2003/05/06 14:30
-	0	9/788,263	USPAT; US-PGPUB	2003/05/06 14:30
-	1	09/785,975	USPAT; US-PGPUB	2003/05/06 14:31
-	2	09/788,263	USPAT; US-PGPUB	2003/05/06 14:31
-	4	thermoform$3 same (metallizing metallising) same (chamber apparatus)	USPAT; US-PGPUB	2003/05/06 14:40
-	5	5811050.URPN.	USPAT	2003/05/06 14:36
-	7	"27610"	EPO; JPO; DERWENT	2003/05/06 14:41
-	165	118/$.ccls. and ((chamber enclosure apparatus) with (triang$4))	USPAT; US-PGPUB	2003/05/06 15:21
-	5	5364481.URPN.	USPAT	2003/05/06 14:55
-	1	"5108540".PN.	USPAT	2003/05/06 15:06
-	2	6291800.URPN.	USPAT	2003/05/06 15:07
-	1	"5525159".PN.	USPAT	2003/05/06 15:15
-	1	6357385.URPN.	USPAT	2003/05/06 15:15
-	12299	118/$.ccls. and (rotat$3)	USPAT; US-PGPUB	2003/05/06 15:22
-	681	118/715.ccls. and (rotat$3)	USPAT; US-PGPUB	2003/05/06 15:22
-	627	118/719.ccls. and (rotat$3)	USPAT; US-PGPUB	2003/05/06 15:30
-	245	118/719.ccls. and (rotat$3 with (surface face side))	USPAT; US-PGPUB	2003/05/06 15:33
-	273	118/715.ccls. and (rotat$3 with (surface face side))	USPAT; US-PGPUB	2003/05/06 15:32
-	484	(118/719.ccls. and (rotat$3 with (surface face side))) (118/715.ccls. and (rotat$3 with (surface face side)))	USPAT; US-PGPUB	2003/05/06 15:34
-	169	(metal with (coat$3 deposit$3)) same shap$3 same cut$4 same (apparatus chamber convey$3 station)	USPAT; US-PGPUB	2003/05/08 12:11
-	169	(metal with (coat$3 deposit$3)) same shap$3 same cut$4 same (apparatus chamber convey$3 station)	USPAT; US-PGPUB	2003/05/08 12:14

–	38	(metal with (coat$3 deposit$3)) same shap$3 same cut$4 same (apparatus chamber convey$3 station)	EPO; JPO; DERWENT	2003/05/08 14:58
–	1	("4201837").PN.	USPAT; US-PGPUB	2003/05/08 18:02
–	1	("5503941").PN.	USPAT; US-PGPUB	2003/05/08 18:02
–	16	118/$.ccls. and ((conic$ triangl$) with (out outward) with direct$3)	USPAT; US-PGPUB	2003/05/09 10:59
–	80	((conic$ triangl$) with (out outward) with direct$3) with chamber	EPO; JPO; DERWENT	2003/05/08 20:26
–	52	c23c016$.ipc. and ((conic$ triangl$) with (chamber apparatus))	EPO; JPO; DERWENT	2003/05/08 20:27
–	18	118/$.ccls. and ((conic$ triangl$) with (chamber apparatus))	EPO; JPO; DERWENT	2003/05/08 20:44
–	546	118/$.ccls. and ((conic$ triangl$) with (chamber apparatus))	USPAT; US-PGPUB	2003/05/08 20:49
–	1	("4161356").PN.	USPAT; US-PGPUB	2003/05/08 20:45
–	25	4161356.URPN.	USPAT	2003/05/08 20:46
–	137	118/$.ccls. and ((conic$ triangl$) with (chamber apparatus) with (flow$3 direct$3))	USPAT; US-PGPUB	2003/05/08 20:50